

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3803112

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHUN-CHI LAI	03/22/2016
CHEE-WAI LAU	03/22/2016
FENG-SHENG LIN	03/22/2016
YI-RU SU	03/23/2016
CHI-CHUN LIAO	03/23/2016
RONG-ANN LIN	03/24/2016
CHIA-PING LU	03/24/2016
AN-HSIUNG HSIEH	03/22/2016
PEI-YU CHEN	03/22/2016
TSANG HONG WANG	03/24/2016
TZU-CHI TSENG	03/26/2016
CHUNG-HAO CHENG	03/22/2016
HSU SHENG HSU	03/22/2016

RECEIVING PARTY DATA

Name:	AU OPTRONICS CORP.
Street Address:	No.1, Li-Hsin Road 2, Science-Based Industrial Park
City:	Hsin-Chu
State/Country:	Taiwan ROC
Postal Code:	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15082511

CORRESPONDENCE DATA

Fax Number: (703)880-7487

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 703-639-0151

Email: assignment@WPAT.COM

Correspondent Name: WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS

Address Line 1: 8230 BOONE BLVD, SUITE 405

PATENT

Address Line 4:	VIENNA, VIRGINIA 22182
ATTORNEY DOCKET NUMBER:	66007-904
NAME OF SUBMITTER:	JUSTIN KING
SIGNATURE:	/Justin King/
DATE SIGNED:	03/28/2016
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 5 source=CDAssignment#page1.tif source=CDAssignment#page2.tif source=CDAssignment#page3.tif source=CDAssignment#page4.tif source=CDAssignment#page5.tif	

AU1408014

Derivation of PTO/ATA/01, 02 (Rev. 6-12)
Copyright © 2012 WPAT, PCAU1408074US
13530AUO-US**Combined Declaration and Assignment for Patent Application**

In Chinese/English

美國專利申請聲明以及美國專利轉讓

For the subject matter which is claimed and for which a patent is sought on the invention entitled:
專利申請權利要求的發明名稱如下:

TOUCH DISPLAY APPARATUS

I hereby declare that: As a below named inventor
我在此宣告：作為下述發明者

The specification of which is attached hereto unless the following box is checked 並將其說明書在此附上，除非以下方格已打叉：

was filed on 其發明已立案于

as United States Application Number or PCT International Application Number 其美國申請號碼或 PCT 國際申請號碼為

The above-identified application was made or authorized to be made by me.
以上所提之申請案係由我撰寫或是在我的授權下所撰寫。

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.
我相信我是首創發明者或是首創共同發明者。

I hereby acknowledge that willful false statements made in this statement is punishable under 18 U.S.C. 1001 by fine or/and imprisonment of not more than five (5) years.
我了解，按照美國法規第十八節第一千零一項，任何蓄意偽造的聲明都可受到罰款和/或五年以下有期徒刑。

ASSIGNMENT**美國專利轉讓**

WHEREAS, I(we), the named inventor(s), whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR.
作為下述其郵遞地址的發明者，在此稱轉讓人。

WHEREAS, AU Optronics Corp.
whose post office address is No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.
hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions.

AU Optronics Corp. 位於 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C., 在此稱讓受人，取得此發明在美國與其管轄境內之所有權利。

Pages 1 of 5

Derivation of PTO/AIA/01, 02 (Rev. 6-12)
Copyright © 2012 WPAT, PC

AU1408074US
13530AUO-US

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part, and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

根據所收到的相關價值，轉讓人據此將本發明轉讓於讓受人。此轉讓包括本發明以及本發明案之所有在美國的相關權利，包括任何專利有效期內的分案、續案、重新核發案，並包括在國際公約所保障的優先權。

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

轉讓人將不會簽署任何與此轉讓書相悖逆的再轉讓、販售、或合同協議。

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives;

轉讓人將無條件協助簽署任何法律上所需要與本發明相關的文件，包括提交申請、回駁答辯、年費，以及任何證明讓受人擁有本發明之文件。在讓受人的要求下，轉讓人也將無條件協助讓受人，提供讓受人轉讓人所持有的發明文件資料，並提供讓受人或是讓受人的法定繼承人在法律上所要求的回駁答辯、侵權訴訟相關協助。

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made. 轉讓人在此要求美國專利商標局在核發本發明專利時，根據以上所陳述讓受人在本發明以及本發明案之所有在美國的相關權利，核發於讓受人。

Derivation of PTO/AIA/D1_02 (Rev. 6-12)
Copyright © 2012 WPAT, PCAU1408074US
13530AUG-US

Legal Name of the Sole Or First Inventor 第一或是唯一發明者正式名字		
LAI, CHUN-CHI		
Signature 發明者簽字 <i>Lai, Chun-Chi</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
LAU, CHEE-WAI		
Signature 發明者簽字 <i>LAU, CHEE-WAI</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Malaysia	
Legal Name of the Joint Inventor 共同發明者正式名字		
LIN, FENG-SHENG		
Signature 發明者簽字 <i>LIN, FENG-SHENG</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
SU, YI-RU		
Signature 發明者簽字 <i>SU, YI-RU</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
LIAO, CHI-CHUN		
Signature 發明者簽字 <i>LIAO, CHI-CHUN</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/23	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	

Derivation of PTO/AIA 01.02 (Rev. 6-12)
Copyright © 2012 WPAT, PCAU1408074US
13530AUO-US

Legal Name of the Joint Inventor 共同發明者正式名字		
LIN, RONG-ANN		
Signature 發明者簽字 <i>LIN Rongann</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/24	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
LU, CHIA-PING		
Signature 發明者簽字 <i>Lu, Chia ping</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/24	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
HSIEH, AN-HSIUNG		
Signature 發明者簽字 <i>Hsieh An-Hsiung</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
CHEN, PEI-YU		
Signature 發明者簽字 <i>Chen Pei-yu</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
WANG, TSANG HONG		
Signature 發明者簽字 <i>Wang Tsang Hong</i>	Signature Date (month/day/year) 簽字日期(月/日/年) 2016/3/24	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	

Division of PTO/AIA/01, 02 (Rev. 6-12)
Copyright © 2012 WPAT, PC

AU1408074US
I3530AUO-US

Legal Name of the Joint Inventor 共同發明者正式名字		
TSENG, TZU-CHI		
Signature 發明者簽字 Tseng Tzu Chi	Signature Date (month/day/year) 簽字日期(月/日/年) 2016.03.26	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
CHENG, CHUNG-HAO		
Signature 發明者簽字 Cheng Chung-hao.	Signature Date (month/day/year) 簽字日期(月/日/年) 2016.03.22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	
Legal Name of the Joint Inventor 共同發明者正式名字		
HSU, HSU SHENG		
Signature 發明者簽字 Hsu, Hsu, SHENG	Signature Date (month/day/year) 簽字日期(月/日/年) 2016 / 3 / 22	
Mailing Address 郵寄地址 No.1, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.	Citizenship 國籍 Taiwan	